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IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Solar Inverters
- Uninterruptible Power Supplies (UPS)

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	100 50	A
Diode Forward Current @ Tc = 25°C @ Tc = 100°C	I _F	100 50	A
Diode Pulsed Current T _{PULSE} Limited by T _J Max	I _{FM}	200	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	200	A
Short–circuit withstand time V_{GE} = 15 V, V_{CE} = 300 V, $T_J \le +150^{\circ}C$	t _{SC}	5	μs
Gate-emitter voltage	V _{GE}	±20	V
Transient gate-emitter voltage (T _{PULSE} = 5 μs, D < 0.10)		±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	223 89	W
Operating junction temperature range	ТJ	-55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

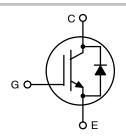
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

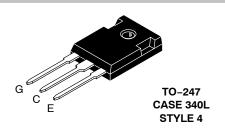


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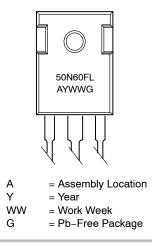
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50 A, 600 V V_{CEsat} = 1.65 V E_{OFF} = 0.6 mJ





MARKING DIAGRAM



ORDERING INFORMATION

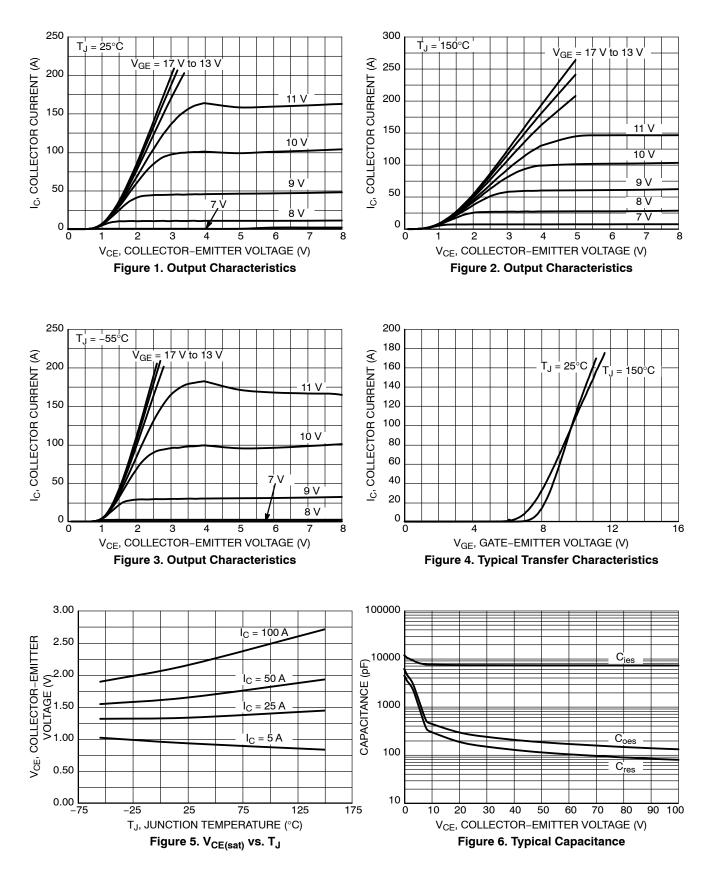
Device	Package	Shipping
NGTB50N60FLWG	TO-247 (Pb-Free)	30 Units / Rail

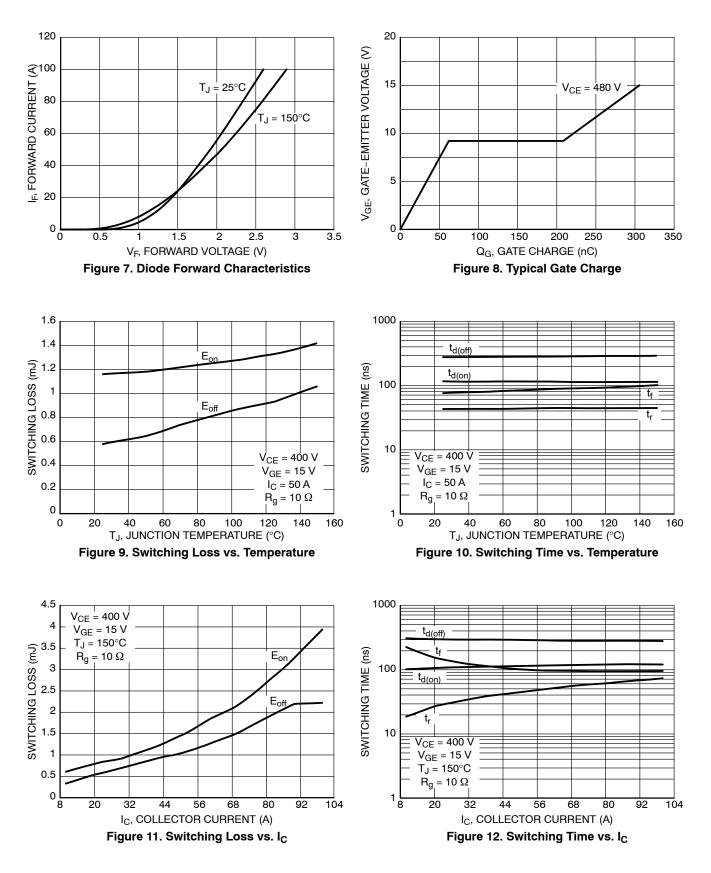
THERMAL CHARACTERISTICS

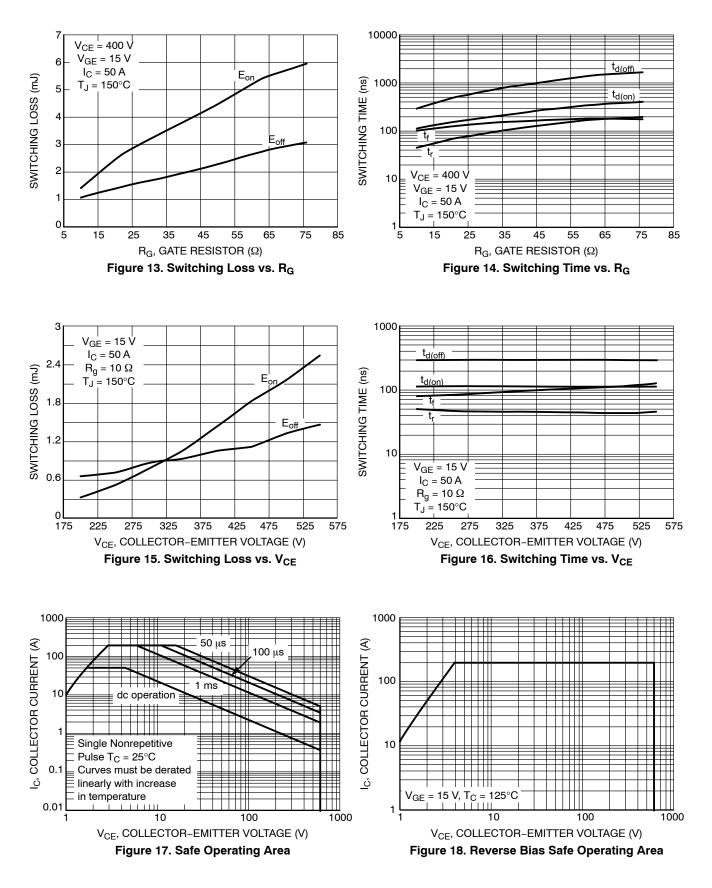
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.56	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	0.74	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•			•		
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	600	-	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V_{GE} = 15 V, I _C = 50 A, T _J = 150°C	V _{CEsat}	1.40 _	1.65 1.85	1.90 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 600 V$ $V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150^{\circ}C$	I _{CES}			0.5 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	_	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	7500	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	300	-	
Reverse transfer capacitance	1	C _{res}	-	190	-	
Gate charge total		Qg	-	310	-	nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 50 A, V _{GE} = 15 V	Q _{ge}	-	60	-	
Gate to collector charge	1	Q _{gc}	-	150	-	
SWITCHING CHARACTERISTIC, INDUCT						
Turn–on delay time		t _{d(on)}	_	116	-	ns
Rise time	1	t _r	_	43	-	
Turn-off delay time	$T_{\rm J} = 25^{\circ}C$	t _{d(off)}	_	292	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 50 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	78	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	E _{on}	_	1.1	-	mJ
Turn-off switching loss	1	E _{off}	_	0.6	-	
Total switching loss	1	E _{ts}	_	1.7	-	
Turn-on delay time		t _{d(on)}	-	110	-	ns
Rise time	1	t _r	-	45	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	300	-	
Fall time	V_{CC} = 400 V, I _C = 50 A R _g = 10 Ω	t _f	-	105	-	
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	1.4	-	mJ
Turn-off switching loss		E _{off}	-	1.1	-	
Total switching loss	1	E _{ts}	-	2.5	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 50 A V_{GE} = 0 V, I _F = 50 A, T _J = 150°C	V _F	1.55 -	1.85 1.85	2.1 _	V
Reverse recovery time	T.I = 25°C	t _{rr}	_	85	-	ns
Reverse recovery charge	I _F = 50 Å, V _R = 200 V	Q _{rr}	_	0.40	-	μC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	_	8	_	А







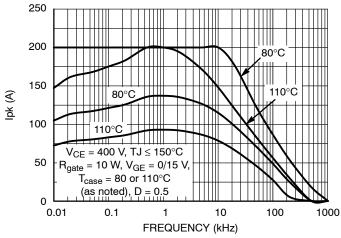


Figure 19. Collector Current vs. Switching Frequency

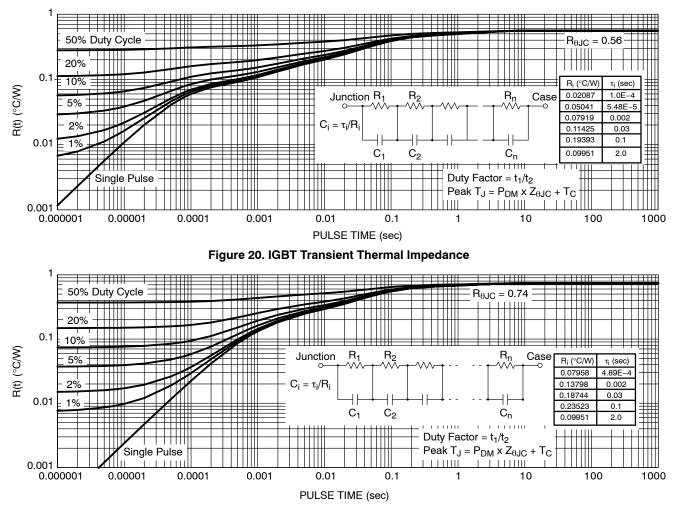


Figure 21. Diode Transient Thermal Impedance

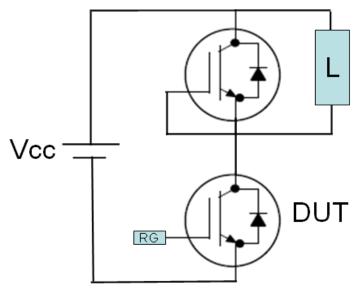
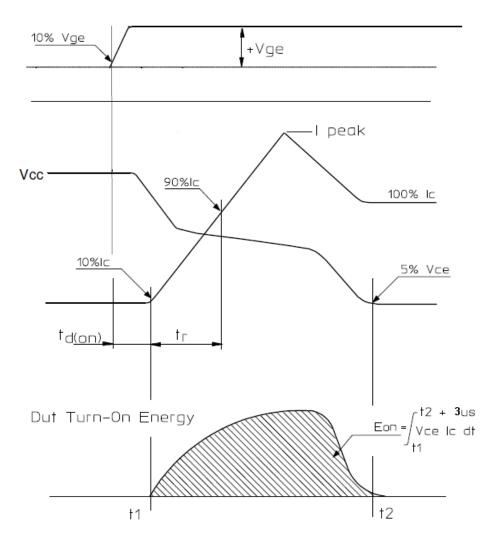
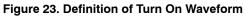


Figure 22. Test Circuit for Switching Characteristics





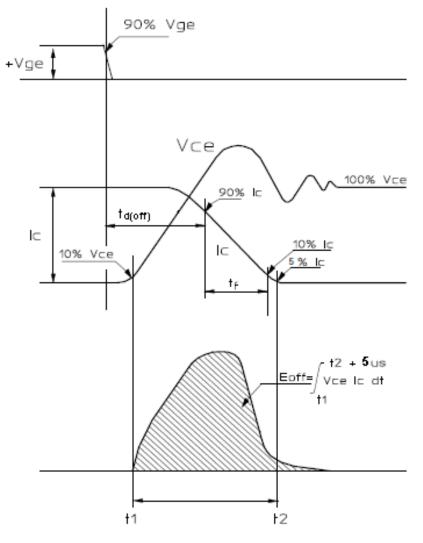
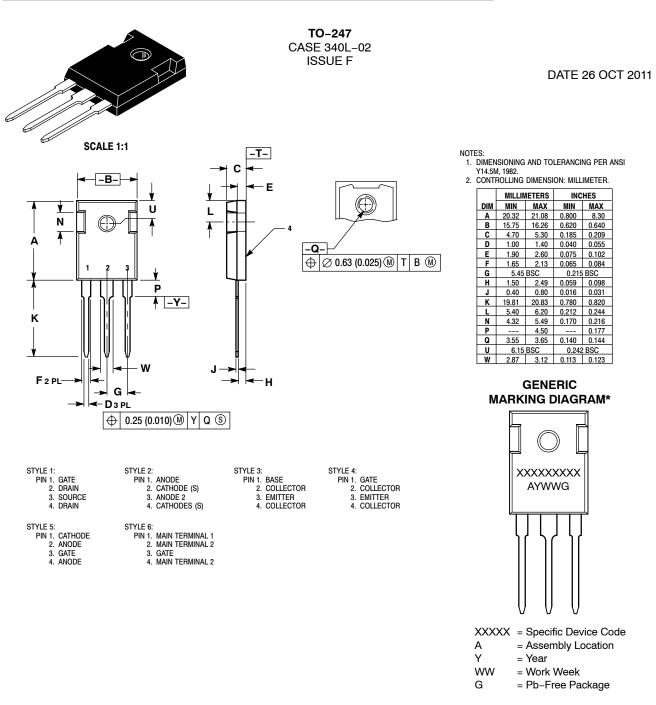


Figure 24. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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PAGE 2 OF 2

ISSUE	REVISION	DATE
D	CHANGE OF OWNERSHIP FROM MOTOROLA TO ON SEMICONDUCTOR. DIM A WAS 20.80–21.46/0.819–0.845. DIM K WAS 19.81–20.32/0.780–0.800. UPDATED STYLE 1, ADDED STYLES 2, 3, & 4. REQ. BY L. HAYES.	25 AUG 2000
E	DIM E MINIMUM WAS 2.20/0.087. DIM K MINIMUM WAS 20.06/0.790. ADDED GENERIC MARKING DIAGRAM. REQ. BY S. ALLEN.	26 FEB 2010
F	ADDED STYLES 5 AND 6. REQ. BY J. PEREZ.	26 OCT 2011

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